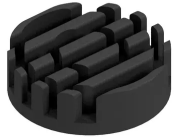


Data sheet Product ICK LED R 33 x 10 G



Heatsinks and active heatsinks for processors>Heatsinks for LEDs
 Ø 33 x 10 mm, for IC design LED

Features

| | |
|---------------------|---|
| diameter: | 33 mm |
| way of fixation: | <ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive |
| height: | 10 mm |
| plate thickness: | 3 mm |
| thermal resistance: | 18.15 - 3.8 K/W |
| dissipation loss: | 6.6 W |
| surface: | black anodised |

Technical Drawing

